

App. Ser. No. 10/735,698

Amendment dated Apr. 19, 2007

Reply to Office action dated Jan. 19, 2007

Docket No. AB-1625-2C US
(Ref. No. LW5009US(DV)(CA))**REMARKS/ARGUMENTS**

The following remarks are in reply to the non-final Office action of 01/19/07 in this application. In light of this reply, reconsideration and further examination of this application are respectfully requested.

Twenty claims (13-20 and 22-33) were pending in this application. In this reply, 3 claims (18, 32 and 33) were amended, and none was added or cancelled. Accordingly, 20 claims (13-20 and 22-33) remain pending for reconsideration and further examination.

In section 1 of the Office action, the Examiner rejected claims 13-20, 22-30 and 31-33 under 35 U.S.C. 102(b) as being anticipated by Ueda et al. (US5838412), stating, in pertinent part,

“... Ueda et al. teach (Figs. 1-6) a display device comprising:

a bottom casing 50 [; and,]

a printed circuit board PCB 21 connected to said display panel; *the PCB being disposed below the bottom chassis 50.*” (Emphasis added.)

In light of the above amendments to claims 32 and 33 and the remarks that follow, this rejection is respectfully traversed.

Independent claims 13, 18, 32 and 33 previously included or have been amended to respectively include the following distinguishing limitations:

Claim 13: “... a printed circuit board (PCB) connected to said display panel, the PCB being disposed below the bottom chassis”;

Claim 18: “... wherein the chassis is disposed between the display panel and the PCB”;

Claim 32: “... a printed circuit board (PCB) disposed below and connected to said bottom chassis”; and,

Claim 33: “... wherein the chassis is disposed between the display panel and the PCB.”

Initially, it is noted that the Ueda '412, or at least Figs. 1-6 thereof, is devoid of any reference numerals, and instead, makes use of rather cryptic acronyms, such as “SHD,” “PCB,” and “MCA.” Accordingly, the Applicant has been unable to locate any of the features referred to by the Examiner above, e.g., “PCB 21” and “bottom chassis 50.”

In any case, however, Ueda '412 teaches an LCD device in which a “PCB” is bonded to a lower surface of one glass substrate (“SUB 1”) of an LCD panel “PNL” by means of a double-backed adhesive tape “BAT” and is electrically connected to components on an upper surface of a second substrate (“SUB 2”) by means of a multilayered flexible printed circuit “FPC1” bent

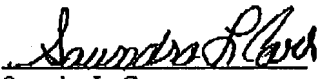
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through an angle of 180 degrees. However, there is no teaching or suggestion whatsoever in Ueda '412 for a "chassis" disposed between the PCB and the LCD panel or the PCB being disposed below a "bottom chassis," as distinctly claimed in independent claims 13, 18, 32 and 33 above. (Compare, e.g., Figs. 27A and 28 of the '412 with Fig. 5 of the instant application.)

In light of the foregoing differences, it is respectfully submitted that independent claims 13, 18, 32 and 33, as well as the claims respective dependent from them, are patentably distinguishable over Ueda et al. '412. Accordingly, it is respectfully submitted that claims 13-20 and 22-33 are allowable over the art of record. Applicant therefore respectfully requests that a timely Notice of Allowance be issued in this case.

If there are any questions regarding this reply, the Examiner is invited to contact the undersigned at the number below. The Commissioner is also authorized to charge any additional fees required and credit any overpayment to Deposit Account No. 50-2257.

Certification of Facsimile Transmission	
I hereby certify that this paper is being facsimile transmitted to the U.S. Patent and Trademark Office on the date shown below.	
	April 19, 2007
Sandra L. Carr	Date of Signature

Respectfully submitted,



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